	03-15-19	999		
Form I 1-31-92	ГО-1595		U.S. Department of Commerce Patent and Trademark Office	
o the Ho	norable Commissioner of Patents and 1009816	77	uments or copy thereof.	
Rober Subrar Scott I Kevin Addit ¹ 3. Nati [X] [] Se [] C [] O	ne of conveying party(ies) t Hannon manian S. Iyer R. Stiffler R. Winstel name(s) of conveying party(ies) attached? [] Yes X Hour Market ure of conveyance: Assignment [] Merger ecurity Agreement hange of name ther tion Date: 1/21/99	Interna New O Armon	ne and address of receiving party(ies): ational Business Machines Corporation Orchard Road nk, New York 10504 I. name(s) & address(es) attached? [] Yes [X] No	
4.	Application number(s) or patent number(s): 09/197,6 If this document is being filed together with a new ap	93 oplication	, the execution date of the application is:	
	A. Patent Application No.(s)		B. Patent No.(s)	
	Additional numbers	attached?	(] Yes [X] No	
5.	Name and address of party to whom correspondence concerning document should be mailed:	6.	Total number of applications and patents involved [1]	
	mailed: Pollock, Vande Sande & Amernick Suite 800 1990 M Street, N.W. Washington State: D.C. Zip: 20036		Total fee (37 CFR 3.41)\$40.00 [] Enclosed [XX] Authorized to be charged to deposit account [XX] Charge deficiencies/credit overpayments to Deposit Account 09-0458	
	Wushington Glato. Drei Lipi Loore	8.	Deposit Account No: 09-0458 (Attach duplicate copy of this page if paying by deposit account)	
	DO NOT US	SE THIS SP	PACE	
9.	Statement and signature. To the best of my knowledge and belief, the foregoin true copy of the original document.		ation is true and correct and any attached copy is a Total number of pages including cover sheet: [3]	
	Do not deta	ach this po	ortion	
1/1999 M C:581	Mail documents to be recorded with required cover sh TEKLEMI 00000136 090458 09197693 40.00 CH Commissioner of P Box As Washingto	atents and ssignments	i Trademarks s	
	Public burden reporting for this sample cover sheet is a recorded, including time for reviewing the document an the sample cover sheet. Send comments regarding this Office of Information Systems, PK2-1000C, Washington Paperwork Reduction Project (0651-0011), Washington	d gatherin burden es ,D.C. 2023	ng the data needed, and completing and reviewing stimate to the U.S. Patent and Trademark Office, 31, and to the Office of Management and Budget,	
	Office of Information Systems, PK2-1000C, Washington	,D.C. 2023	31, and to the Office of Management and Budget,	

PATENT REEL: 9806 FRAME: 0069

(IBM Docket No.: FI9-98174) ASSIGNMENT

Whereas, We

(1)	Robert Hannon	City of Wappingers Falls
County of	Dutchess	and State of New York
(2)	Subramanian S. Iyer	City of Mt. Kisco
County of	Westchester	and State of New York
(3)	Scott R. Stiffler	City of Amenia
County of	Dutchess	and State of New York
(4)	Kevin R. Winstel	City of Hopewell Junction
County of	Dutchess	and State of New York

have invented certain improvements in

Method For Filtering Dislocation In Merged SOI/DRAM Chips

and have executed, respectively, a United States patent application therefor on

(1)	Jen 21	199 <i>1</i> .
(2)	Jan 21	199 9 .

- (3)
- Jan 21 1999. (4)

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504 (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents obtained therefor:

Now, therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights FI9-98-174 (2/2)

of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, it successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

(1) Signed at EAST FISHKILL, NY

on

1/21/99

Signature

Robert Hannon

(2) Signed at EAST FISHKILL, NY

on

1/2/99

(3) Signed at EAST FISHKILL, NY

on

1/21/99

(4) Signed at EAST FISHKILL, NY

ma curic Signature

Signature Scott R. Stiffler

Kun R Winet

Signature

on

1/21/99